



Product Change Notification

Change Notification #: 115318 - 00
Change Title: Select Intel® X-GOLD™ 213 Series Products, PCN 115318-00, Product Discontinuance, End of Life
Date of Publication: March 13, 2017

Key Characteristics of the Change:

Product Discontinuance

Forecasted Key Milestones:

Last Product Discontinuance Order Date:	March 13, 2017
Last Product Discontinuance Shipment Date:	March 13, 2017

Description of Change to the Customer:

The Select Intel® X-GOLD™ 213 Series Products listed on the "Products Affected/Intel Ordering Codes" table below will be discontinued and unavailable for additional orders after the "Last Product Discontinuance Order Date" (see "Key Milestones" above).

Customer Impact of Change and Recommended Action:

This notification is for recordkeeping only, the product is no longer available. See your local Intel Sales Representative for alternative products

Products Affected / Intel Ordering Codes:

Marketing Name	Product Code	S-Spec	MM#
Intel® X-GOLD™ 213	PMB8810V2.0	S LHMT	913610
Intel® X-GOLD™ 213	PMB8810V2.0	S LHSB	913794
Intel® X-GOLD™ 213	PMB8810V2.0	S LHTA	913831
Intel® X-GOLD™ 213	PMB8810V2.0	S LHPW	913900
Intel® X-GOLD™ 213	PMB8810E2.0K11	S LHZF	913991
Intel® X-GOLD™ 213	PMB8810E2.0K11	S LHZ8	913996
Intel® X-GOLD™ 213	PMB8810E2.1	S LHZ5	913997
Intel® X-GOLD™ 213	PMB8810V2.0	S LHNJ	914019
Intel® X-GOLD™ 213	PMB8810V2.0	S LHNF	914022
Intel® X-GOLD™ 213	PMB8810V2.0	S LHHP	914171
Intel® X-GOLD™ 213	PMB8810V2.0	S LHHN	914172
Intel® X-GOLD™ 213	PMB8810V2.0	S LJF4	917745
Intel® X-GOLD™ 213	PMB8810V2.0	S LJF6	917747
Intel® X-GOLD™ 213	PMB8810V2.0	S LJGF	918032
Intel® X-GOLD™ 213	PMB8810V2.0	S LJS9	921984

PCN Revision History:

Date of Revision: March 13, 2017	Revision Number: 00	Reason: Originally Published PCN
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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Email: IMC.PCN.ASMO@intel.com
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